

Analog absolute pressure sensor, 20 to 250 kPa Rev. 4.1 — 29 May 2019 Pr

Product data sheet

1 General description

The FXPS7250A4 high-performance, high-precision absolute pressure sensor consists of a compact capacitive micro-electro-mechanical systems (MEMS) device coupled with a digital integrated circuit (IC) producing a fully calibrated analog output.

This sensor is ideal for many automotive applications such as manifold air pressure (MAP), comfort seating and other applications requiring operating absolute pressure ranges up to 250 kPa.

The sensing element is based on NXP's high precision capacitive pressure cell technology. The architecture benefits from redundant pressure transducers as an expanded quality measure. It delivers highly accurate ratiometric analog readings of absolute pressure while operating from either a 3.3 V or 5.0 V power supply.

The sensor operates over a pressure range of 20 kPa to 250 kPa and over a wide temperature range of –40 ^{o}C to 130 ^{o}C

The sensor comes in an industry-leading 4 mm x 4 mm x 1.98 mm, restriction of hazardous substances (RoHS) compliant, high-power quad flat no-lead (HQFN)

package^[1] suitable for small printed circuit board (PCB) integration. Its AEC-Q100^[2] compliance, high accuracy, reliable performance and high media resistivity make it ideal for use in automotive, industrial, and consumer applications.

2 Features and benefits

- Absolute pressure range: 20 to 250 kPa
- Operating temperature range: -40 °C to 130 °C
- Analog output for monitoring of the absolute pressure signal
- Pressure transducer and digital signal processor (DSP)
 Internal self test
- Capacitance to voltage converter with anti-aliasing filter
- Sigma delta ADC plus sinc filter
- 800 Hz or 1000 Hz low-pass filter for absolute pressure
- Lead-free, 16-pin HQFN, 4 mm x 4 mm x 1.98 mm package

3 Applications

3.1 Automotive

- Manifold air pressure
 - MAP
- Small engine control
- Liquid propane gas (LPG) or compressed natural gas (CNG) engine management



Analog absolute pressure sensor, 20 to 250 kPa

3.2 Industrial

- Compressed air
- Manufacturing line control
- · Gas metering
- Weather stations

3.3 Medical/Consumer

- Blood pressure monitor
- Medicine dispensing systems
- · White goods

4 Ordering information

Table 1. Ordering information

Type number	Package						
	Name	Description	Version				
FXPS7250A4	HQFN16	HQFN16, plastic, thermal enhanced quad flat pack; no leads; 16 terminals; 0.8 mm pitch; 4 mm x 4 mm x 1.98 mm body	SOT1573-1				

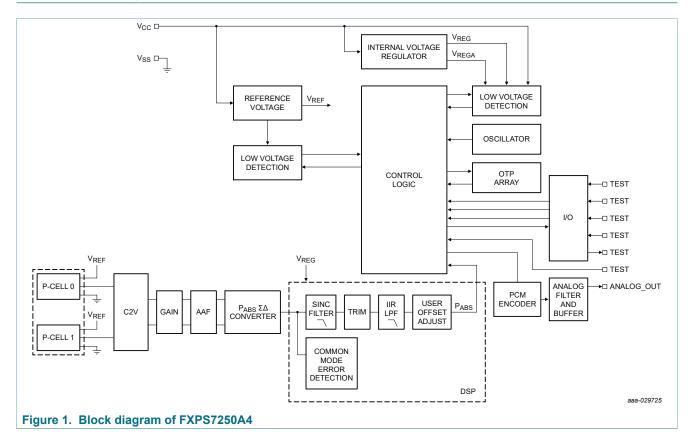
4.1 Ordering options

Table 2. Ordering options

01			
Device	Range (kPa)	Packing	Temperature range
FXPS7250A4T1	20 to 250 kPa	Packing Tape and Reel	–40 °C to 130 °C

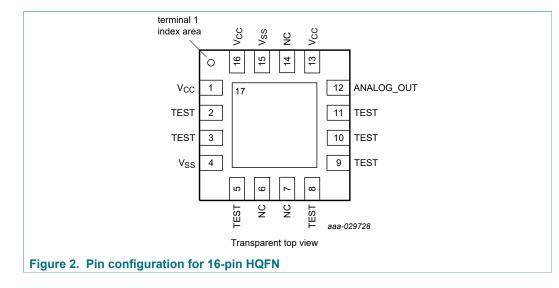
Analog absolute pressure sensor, 20 to 250 kPa

5 Block diagram



6 **Pinning information**





Analog absolute pressure sensor, 20 to 250 kPa

6.2 Pin description

Table 3. Pin description

Pin	Pin name	Description
2, 5, 8, 9, 10, 11	TEST	Pins 2, 5, 8, 9, 10 and 11 are test pins and must be left unterminated in the application.
3	TEST	Pin 3 is required to be tied to V_{CC} for device operation.
4, 15	V _{SS}	Pins 4 and 15 are the supply return nodes and are connected internally to the die attach pad (pin 17).
6, 7, 14	NC	Pins 6, 7 and 14 are not internally connected and can be left unconnected in the application.
12	ANALOG_OUT	Pin 12 provides a ratiometric analog output proportional to the absolute pressure sensor data.
1, 13, 16	V _{CC}	Pins 1, 13 and 16 supply power to the device. An external capacitor must be connected between these pins and $V_{SS},$ as shown in the application diagram.
17	PAD	Pin 17 is the die attach flag and must be connected to $V_{\mbox{SS}}$.

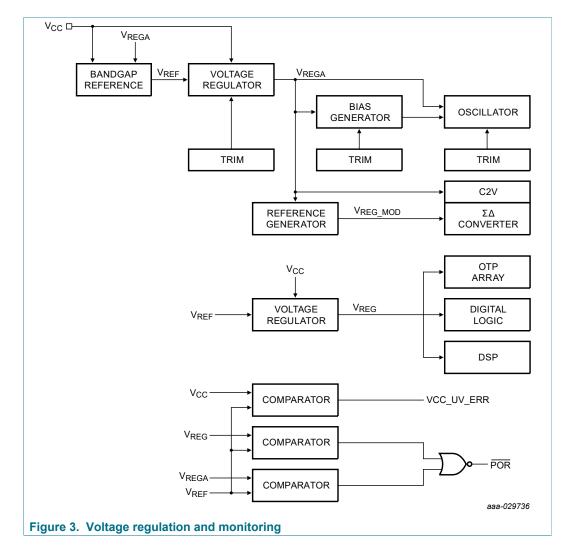
7 Functional description

7.1 Voltage regulators

The device derives its internal supply voltage from the V_{CC} and V_{SS} pins. An external filter capacitor is required for V_{CC}, as shown in <u>Figure 12</u>.

A reference generator provides a reference voltage for the $\Sigma\Delta$ converter.

Analog absolute pressure sensor, 20 to 250 kPa



7.2 Pressure sensor signal path

7.2.1 $\Sigma\Delta$ converter

A second order sigma delta modulator converts the voltage from the analog front end to a data stream that is input to the DSP. A simplified block diagram is shown in <u>Figure 4</u>.

Analog absolute pressure sensor, 20 to 250 kPa

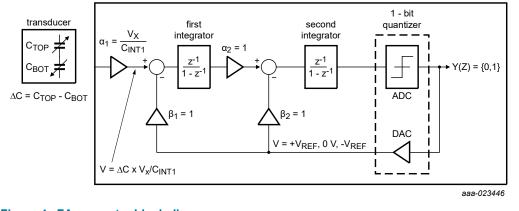


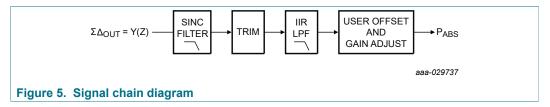
Figure 4. $\Sigma\Delta$ converter block diagram

The sigma delta modulator operates at a frequency of 1 MHz, with the transfer function in Equation 1.

$$H(Z) = \frac{\alpha_1}{Z^2} \tag{1}$$

7.2.2 Digital signal processor (DSP)

A DSP is used to perform signal filtering and compensation. A diagram illustrating the signal processing flow within the DSP is shown in <u>Figure 5</u>.



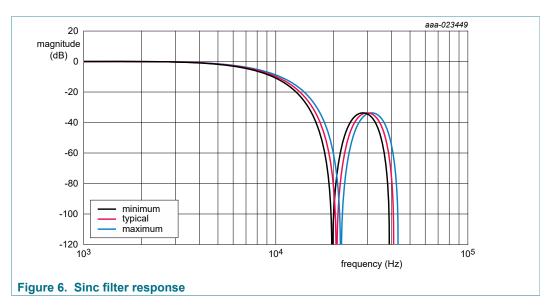
7.2.2.1 Decimation sinc filter

In Equation 2, the output of the $\Sigma\Delta$ modulator is decimated and converted to a parallel value by two third-order sinc filters; the first with a decimation ratio of 24 and the second with a decimation ratio of 4.

$$H(Z) = \left(\frac{1}{24^3}\right) \times \left(\frac{1 - Z^{-24}}{1 - Z^{-1}}\right)^3 \quad H(Z) = \left(\frac{1}{4^3}\right) \times \left(\frac{1 - Z^{-4}}{1 - Z^{-1}}\right)^3 \tag{2}$$

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa



7.2.2.2 Signal trim and compensation

The device includes digital trim to compensate for sensor offset, sensitivity, and nonlinearity over temperature.

7.2.2.3 Low-pass filter

Data from the sinc filter is processed by an infinite impulse response (IIR) low-pass filter with the transfer function and coefficients shown in Equation 3.

$$H(Z) = a_0 \times \frac{(n_{11} \times z^0) + (n_{12} \times z^{-1}) + (n_{13} \times z^{-2})}{(d_{11} \times z^0) + (d_{12} \times z^{-1}) + (d_{13} \times z^{-2})} \times \frac{(n_{21} \times z^0) + (n_{22} \times z^{-1}) + (n_{23} \times z^{-2})}{(d_{21} \times z^0) + (d_{22} \times z^{-1}) + (d_{23} \times z^{-2})}$$
(3)

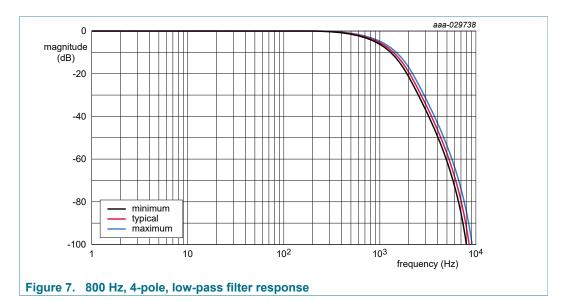
Filter number	Typical –3 dB frequency	Filter order	Filter coefficients (24 bit)				Group delay (µs)	Typical attenuation @ 1000 Hz (dB)
1	800 Hz	4	a ₀	0.088642612609670	—	—	418	4.95
			n ₁₁	0.029638050039039	d ₁₁	1		
			n ₁₂	0.087543281056143	d ₁₂	-1.422792640957290		
			n ₁₃	0.029695285913601	d ₁₃	0.511435253566960	-	
			n ₂₁	0.250241278804809	d ₂₁	1	-	
			n ₂₂	0.499999767379068	d ₂₂	-1.503329908017845	-	
			n ₂₃	0.249758953816089	d ₂₃	0.621996524706640		
2	1000 Hz	4	a ₀	0.129604264748411	—	—	333	2.99
			n ₁₁	0.043719804402508	d ₁₁	1		
			n ₁₂	0.087543281056143	d ₁₂	-1.300502656562698		
			n ₁₃	0.043823599710731	d ₁₃	0.430106921311110	_	
			n ₂₁	0.250296586927511	d ₂₁	1		
			n ₂₂	0.499999648540934	d ₂₂	-1.379959571988366		
			n ₂₃	0.249703764531484	d ₂₃	0.555046257157745		

Table 4. IIR low pass filter coefficients

FXPS7250A4 Product data sheet © NXP B.V. 2019. All rights reserved.

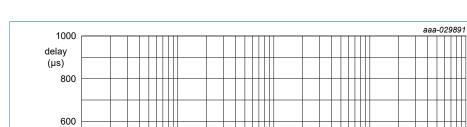
FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa



10²

10³



400

200

0

1

minimum typical maximum

Figure 8. 800 Hz, 4-pole output signal delay

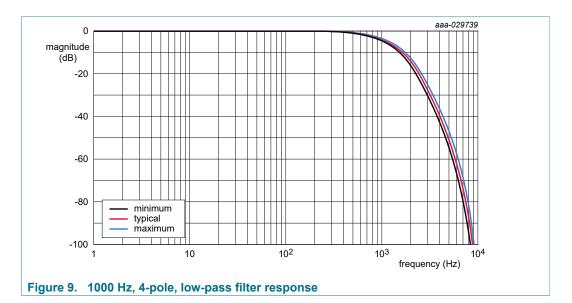
10

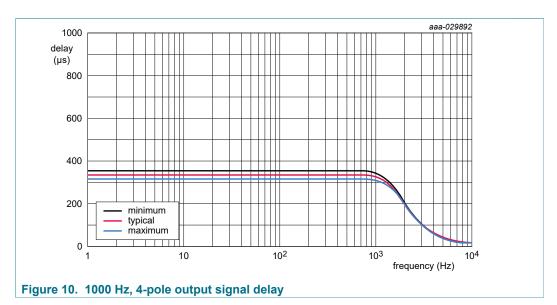
FXPS7250A4 Product data sheet 104

frequency (Hz)

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa





7.3 Analog output function

7.3.1 Analog output signal chain

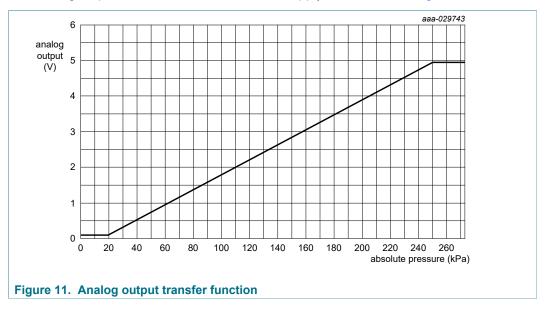
The device provides an analog output ratiometric to the supply voltage. The analog output is enabled by default. Selecting the analog output enables the following functions:

- The non-interpolated P_{ABS} sensor data output is saturated to 10 bits and converted to an unsigned value.
- The 10-bit sensor value is input into a summer clocked at 10 MHz.
- The carry from the summer circuit generates a PCM output.
- The PCM signal is filtered by a 2-pole active low pass filter to generate an analog signal.

Analog absolute pressure sensor, 20 to 250 kPa

7.3.2 Analog output transfer function

The analog output transfer function for a 5.0 V supply is as shown in Figure 11.



8 Maximum ratings

Absolute maximum ratings are the limits the device can be exposed to without permanently damaging it. Absolute maximum ratings are stress ratings only; functional operation at these ratings is not guaranteed. Exposure to absolute maximum ratings conditions for extended periods might affect device reliability.

This device contains circuitry to protect against damage due to high static voltage or electrical fields. NXP advises that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit.

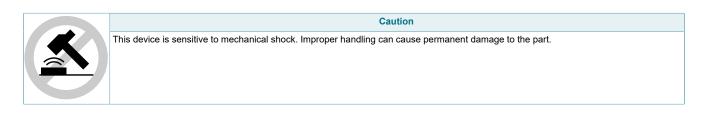
Symbol	Parameter	Conditions		Min	Max	Unit
VCC _{MAX}	Supply Voltage	V _{CC} , V _{CCIO}	[1]	—	+6.0	V
V _{IOMAX}	Input/Output Max on pins	ANALOG_OUT TESTx	[1]	-0.3	V _{CC} + 0.3	V
h _{DROP}	Drop shock	To concrete, tile or steel surface, 10 drops, any orientation	[2]		1.2	m
T _{stg}	Temperature range	Storage	[2]	-40	+130	°C
TJ		Junction	[3]	-40	+150°C	°C
P _{MAX}	Maximum absolute pressure	Continuous	[3]	—	300	kPa
P _{BURST}		Burst (tested at 100 ms)	[2]	—	750	kPa
P _{MIN}	Minimum absolute pressure	Continuous	[1]	—	20	kPa
f _{SEAL}	Pressure sealing force	Applied to top face of package	[1]	—	10	Ν
θ _{JA}	Thermal resistance		[4]	—	120	°C/W
ESD and latch-up	protection characteristics	1		1	1	
V _{ESD}	Electrostatic discharge (per	Human body model (HBM)	[2]	-2000	2000	V
V _{ESD}	AEC-Q100, Rev H)	Charge device model (CDM)	[2] [5]	-500	500	V

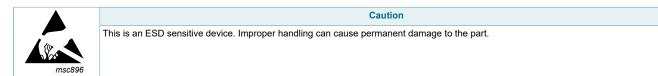
[1] Parameter verified by parametric and functional validation.

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa

- Parameter verified by qualification testing (Per AEC-Q100 Rev H or per NXP specification). [2]
- [3] [4] Functionality verified by modeling, simulation and/or design verification.
- Thermal resistance provided with device mounted to a two-layer, 1.6 mm FR-4 PCB as documented in AN1902 with one signal layer and one ground layer.
- [5] CDM tested at ±750 V for corner pins and ±500 V for all other pins.





Operating range 9

Table 6. Electrical characteristics—supply and I/O

 $V_{CC min} \le (V_{CC} - V_{SS}) \le V_{CC max}, T_L \le T_A \le T_H, \Delta T \le 25 \text{ °C/min, unless otherwise specified.}$

Symbol	Parameter	Conditions		Min	Мах	Units
V _{CC}	Supply voltage	Measured at V _{CC}	[1]	3.10	5.25	V
T _A	Operating temperature range	V _{CC} = 5.0 V, unless otherwise stated. Production tested operating temperature range	[1]	T _L 40	Т _Н +130	°C
T _A		Guaranteed operating temperature range	[1]	-40	+130	°C
V _{CC_RAMP}	Supply power on ramp rate	[2] [[3]	0.00001	10	V/µs

Parameter tested 100 % at final test. [1]

[2] Functionality verified by modeling, simulation and/or design verification.

[3] Parameter verified by parametric and functional validation.

10 Static characteristics

Table 7. Static characteristics

 $V_{CC_min} \le (V_{CC} - V_{SS}) \le V_{CC_max}, T_L \le T_A \le T_H, \Delta T \le 25 \text{ °C/min}, unless otherwise specified.$

Symbol	Parameter	Condition	Min	Тур	Мах	Units
Supply and I/O						
lq	Quiescent supply current	V _{CC} = 5.0 V ^[1]	_	—	8.0	mA
Temperature sensor si	gnal chain					
V _{OH_ANA}	Output high voltage	ANALOG_OUT, [1] Ι _{Load} = –100 μΑ	V _{cc} - 0.2	_	_	V
V _{OL_ANA}	Output low voltage	ANALOG_OUT, [1] I _{Load} = 100 µA	-	—	0.2	V
V _{OUT_3dB}	Analog output low-pass filter frequency typical value	-3 dB, 2-pole ^[2]	8	—	20	kHz
V _{OUT_3dBTol}	Analog output low-pass filter frequency typical tolerance	-3 dB, 2-pole ^[2]	-5	—	5	%
Absolute pressure sen	sor signal chain	1				

All information provided in this document is subject to legal disclaimers.

Product data sheet

FXPS7250A4

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa

Symbol	Parameter	Condition		Min	Тур	Max	Units
P _{ABS}	Absolute pressure range		[1] [3]	20	—	250	kPa
P _{SENS}	Absolute pressure output sensitivity	V _{CC} = 5.0 V. Tested at PA = 140 kPa ± 10 % and 200 kPa ± 10 %	[2]	_	20	_	mV/k Pa
P _{ACC_HIT}	Absolute pressure accuracy	V _{CC} = 5.0 V. 85 °C < T _A ≤ 130 °C	[4]	-3	-	3	%FSS
P _{ACC_Typ}	Absolute pressure accuracy	V _{CC} = 5.0 V. 0° C ≤ T _A ≤ 85 °C	[4]	-2	—	+2	%FSS
P _{ACC_LoT}	Absolute pressure accuracy	V _{CC} = 5.0 V. -40 °C ≤ T _A < 0 °C	[4]	-3	—	+3	%FSS
P _{OFF}	Absolute pressure analog offset	At pressure span extremes V_{CC} = 5.0 V.	[4]	_	0.2	-	V
V _{FSS}	Output voltage span	At pressure span extremes V_{CC} = 5.0 V.	[5]	-	4.6	-	V

Parameter verified by pass/fail testing at final test. [1]

[2] [3] Functionality verified by modeling, simulation and/or design verification.

Parameter verified by characterization.

Parameter tested 100 % at final test.

[4] [5] Parameter verified by functional evaluation.

Dynamic characteristics 11

Table 8. Dynamic characteristics

 $V_{CC min} \le (V_{CC} - V_{SS}) \le V_{CC max}, T_L \le T_A \le T_H, \Delta T \le 25 \text{ °C/min, unless otherwise specified.}$

Symbol	Parameter	Condition		Min	Тур	Мах	Units
Signal chain							
t _{SigChain}	P _{ABS} low-pass filter	Signal chain sample time	[1]	_	48	—	μs
f _{c0}		Cutoff frequency, filter option #0, 4-pole	[1] [2]	—	800	—	Hz
f _{c1}		Cutoff frequency, filter option #1, 4-pole	[1] [2]	_	1000	—	Hz
t _{SigDelay}	Signal delay (sinc filter to output delay, excluding the P _{ABS} LPF)		[1]	_	—	128	μs
f _{Package}	Package resonance frequency		[1]	27.1	-	—	kHz

Functionality verified by modeling, simulation and/or design verification. [1]

Parameter verified by functional evaluation.

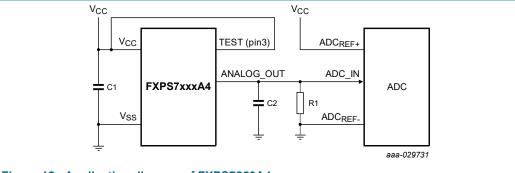
12 Media compatibility—pressure sensors only

For more information regarding media compatibility information, contact your local sales representative.

13 Application information

Note: A gel is used to provide media protection against corrosive elements which may otherwise damage metal bond wires and/or IC surfaces. Highly pressurized gas molecules may permeate through the gel and then occupy boundaries between material surfaces within the sensor package. When decompression occurs, the gas molecules may collect, form bubbles and possibly result in delamination of the gel from the material it protects. If a bubble is located on the pressure transducer surface or on the bond wires, the sensor measurement may shift from its calibrated transfer function. In some cases,

Analog absolute pressure sensor, 20 to 250 kPa



these temporary shifts could be outside the tolerances listed in the data sheet. In rare cases, the bubble may bend the bond wires and result in a permanent shift.

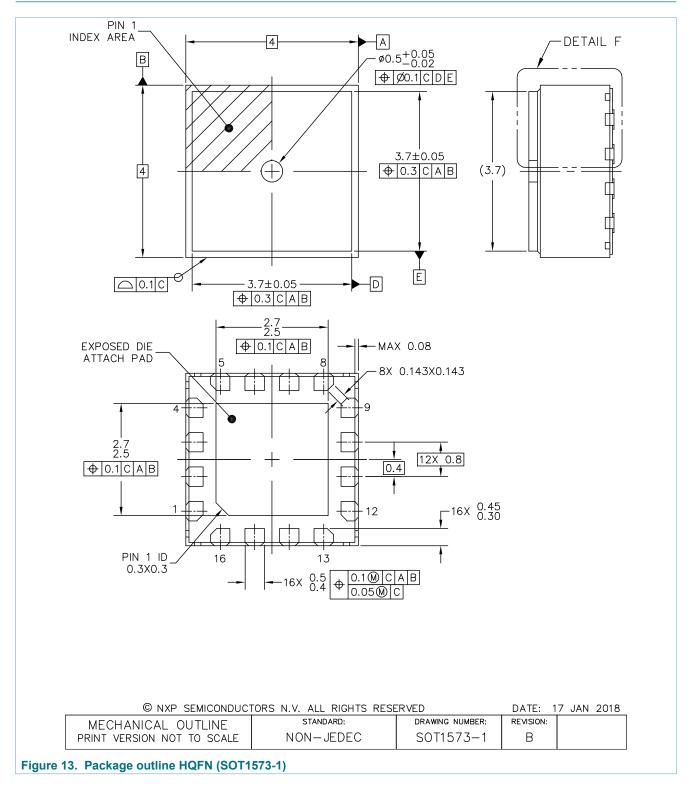
Figure 12. Application diagram of FXPS7250A4

Table 9. External component recommendations

Name	Туре	Description	Purpose
C1	Ceramic	0.1 µF, 10 %, 10 V minimum, X7R	V _{CC} power supply decoupling
C2	Ceramic	47 pF, 10 %, 10 V minimum, X7R	Analog output filtering
R1	General purpose	51 kΩ, 5 %, 200 PPM	Analog output pull-down resistor

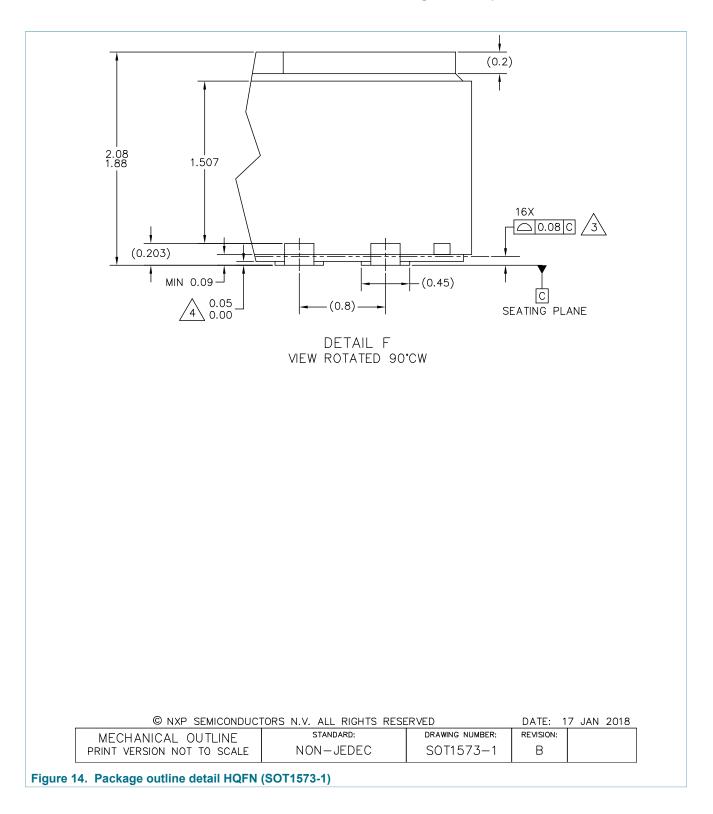
Analog absolute pressure sensor, 20 to 250 kPa

14 Package outline



FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa



FXPS7250A4 Product data sheet

All information provided in this document is subject to legal disclaimers. Rev. 4.1 — 29 May 2019

Analog absolute pressure sensor, 20 to 250 kPa

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3 COPLANARITY APPLIES TO LEADS AND DIE ATTACH PAD.

 $\underline{\cancel{A}}$ dimension applies only for terminals.

5. MIN METAL GAP SHOULD BE 0.2 MM.

	© NXP SEMICONDUC	TORS N.V. ALL RIGHTS RESE	ERVED	DATE: 1	7 JAN 2018
	MECHANICAL OUTLINE	STANDARD:	DRAWING NUMBER:	REVISION:	
	PRINT VERSION NOT TO SCALE	NON-JEDEC	SOT1573-1	В	
Figure 1	15. Package outline note HQFN (SOT1573-1)			

Analog absolute pressure sensor, 20 to 250 kPa

15 References

- [1] Assembly guidelines for quad flat no-lead (HQFN) and small outline no-lead (SON) packages NXP Application Note (AN) 1902, Rev. 8.0 - 6 February 2018, 51 pages, <u>https://www.nxp.com/docs/en/application-note/AN1902.pdf</u>
- [2] AEC documents on Automotive Electronics Council Component Technical Committee's site: http://www.aecouncil.com/AECDocuments.html

Analog absolute pressure sensor, 20 to 250 kPa

16 Revision history

Document ID	Release date	Data sheet status	Change notice	Supercedes			
FXPS7250A4 v.4.1	20190529	Product data sheet	-	FXPS7250A4 v.4			
Modifications • <u>Section 13</u> , Figure 12: Revised the symbol for R1 from a capacitor symbol to a resistor symbol.							
FXPS7250A4 v.4	20190507	Product data sheet	-	FXPS7250A4 v.3			
FXPS7250A4 v.3	20190506	Preliminary data sheet	-	FXPS7250A4 v.2			
FXPS7250A4 v.2	20190408	Preliminary data sheet	-	FXPS7250A4 v.1			
FXPS7250A4 v.1	20180913	Preliminary data sheet	-	-			

Analog absolute pressure sensor, 20 to 250 kPa

17 Legal information

17.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or completing a design. [1]

[2] [3] The term 'short data sheet' is explained in section "Definitions".

The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

17.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet

17.3 Disclaimers

Limited warranty and liability - Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors. In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory. Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors

Right to make changes - NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without

notice. This document supersedes and replaces all information supplied prior to the publication hereof.

 $\ensuremath{\mathsf{Applications}}$ — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products. NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale - NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license - Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Suitability for use in automotive applications - This NXP Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa

to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

17.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

NXP — is a trademark of NXP B.V.

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa

Tables

Ordering information	2
Ordering options	2
Pin description	4
Maximum ratings	10
	Ordering information Ordering options Pin description IIR low pass filter coefficients Maximum ratings

Tab. 6.	Electrical characteristics—supply and I/O 11
Tab. 7.	Static characteristics 11
Tab. 8.	Dynamic characteristics12
Tab. 9.	External component recommendations
Tab. 10.	Revision history18

Figures

Fig. 1.	Block diagram of FXPS7250A4	3
Fig. 2.	Pin configuration for 16-pin HQFN	3
Fig. 3.	Voltage regulation and monitoring	5
Fig. 4.	ΣΔ converter block diagram	6
Fig. 5.	Signal chain diagram	6
Fig. 6.	Sinc filter response	7
Fig. 7.	800 Hz, 4-pole, low-pass filter response	8
Fig. 8.	800 Hz, 4-pole output signal delay	8

Fig. 9.	1000 Hz, 4-pole, low-pass filter response 9
Fig. 10.	1000 Hz, 4-pole output signal delay9
Fig. 11.	Analog output transfer function
Fig. 12.	Application diagram of FXPS7250A413
Fig. 13.	Package outline HQFN (SOT1573-1)14
Fig. 14.	Package outline detail HQFN (SOT1573-1) 15
Fig. 15.	Package outline note HQFN (SOT1573-1) 16

FXPS7250A4 Product data sheet

21 / 22

FXPS7250A4

Analog absolute pressure sensor, 20 to 250 kPa

Contents

1	General description	1
2	Features and benefits	1
3	Applications	1
3.1	Automotive	1
3.2	Industrial	2
3.3	Medical/Consumer	2
4	Ordering information	2
4.1	Ordering options	2
5	Block diagram	
6	Pinning information	3
6.1	Pinning	
6.2	Pin description	4
7	Functional description	4
7.1	Voltage regulators	4
7.2	Pressure sensor signal path	5
7.2.1	ΣΔ converter	
7.2.2	Digital signal processor (DSP)	6
7.2.2.1	Decimation sinc filter	
7.2.2.2	Signal trim and compensation	
7.2.2.3	Low-pass filter	7
7.3	Analog output function	9
7.3.1	Analog output signal chain	
7.3.2	Analog output transfer function	10
8	Maximum ratings	
9	Operating range	
10	Static characteristics	
11	Dynamic characteristics	12
12	Media compatibility—pressure sensors	
	only	12
13	Application information	
14	Package outline	14
15	References	
16	Revision history	
17	Legal information	19

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2019.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 29 May 2019 Document identifier: FXPS7250A4

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Board Mount Pressure Sensors category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

6407-249V-17343P 6407-250V-09273P 80527-25.0H2-05 80541-B00000150-01 80541-B00000200-05 80554-00700100-05 80568-00300050-01 93.631.4253.0 93.731.4353.0 93.932.4553.0 136PC150G2 136PC15A1 142PC95AW71 142PC05DW70 15PSI-G-4V 1805-01A-L0N-B 26PCBKT 26PCCFA6D26 26PCCFS2G 26PCCVA6D 93.632.7353.0 93.731.3653.0 93.931.4853.0 93.932.4853.0 SCDA120-XSC05DC 185PC30DH 20INCH-G-MV-MINI 26PCAFJ3G 26PCCEP5G24 26PCDFA3G 26PCJEU5G19 ASCX15AN-90 TSCSAAN001PDUCV DCAL401DN DCAL401GN XZ202798SSC XZ203676HSC 6407-249V-09343P 6407-250V-17343P SP370-25-116-0 81794-B00001200-01 HSCDLNN100PGAA5 82681-B00000100-01 81618-B0000040-05 SSCDJNN015PAAA5 TSCDLNN100MDUCV TSCSAAN100PDUCV NBPDANN015PGUNV NBPLLNS150PGUNV 142PC100D